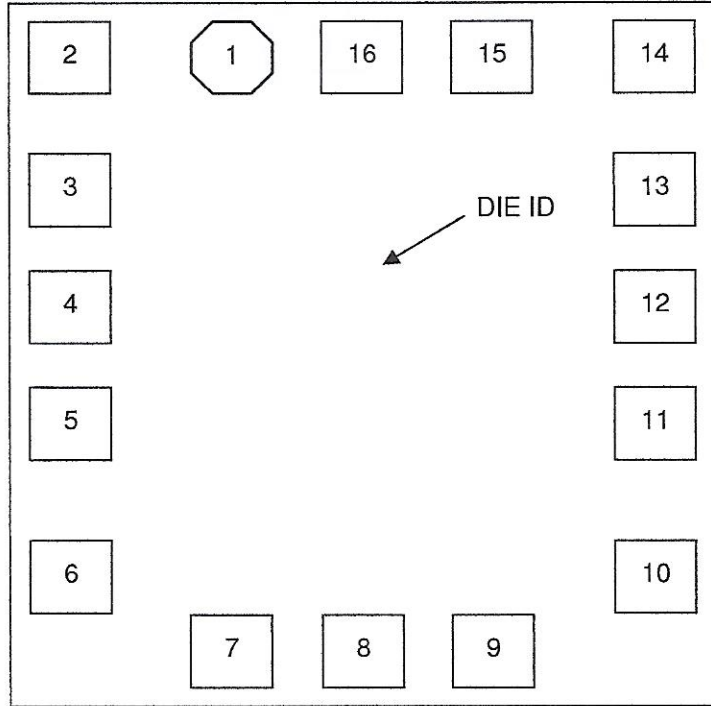




Sierra Components, Inc.

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PAD	FUNCTION
1	$\overline{1E}$
2	S1
3	1I3
4	1I2
5	1I1
6	1I0
7	1Y
8	GND
9	2Y
10	2I0
11	2I1
12	2I2
13	2I3
14	<u>SO</u>
15	2E
16	V _{CC}

NOTE

- This data is supplied for general information only and is believed to be correct at the time of publication.
- For critical applications, the customer is advised to verify device revision and pad coordinates, prior to processing
- Changes can be made without notification from the manufacturer. Die Devices cannot accept liability in that event

DEVICE	54F153	DIE SIZE (MILS)	42 X 42
MANUFACTURER	MOTOROLA	BOND PADS MIN (MILS)	4 X 4
APPROVED BY	GEW	TOP METAL	Al
DATE	26/06/19	BACK METAL	Si
SERIAL NUMBER	0597	BACK POTENTIAL	GND OR FLOAT

APPROVED BY: MG

DIE SIZE: 42 x 42 Mils

DATE: 6/26/19

MFG: Motorola

THICKNESS:

P/N: 54F153